International

- Ultra Low On-Resistance
- Surface Mount (IRFR3910)
- Straight Lead (IRFU3910)
- Advanced Process Technology
- Fast Switching
- Fully Avalanche Rated
- Lead-Free

Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve the lowest possible on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient device for use in a wide variety of applications.

The D-PAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 watts are possible in typical surface mount applications.

Absolute Maximum Ratings

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	16	
I _D @ T _C = 100°C	Continuous Drain Current, VGS @ 10V	12	A
I _{DM}	Pulsed Drain Current 06	60	
P _D @T _C = 25°C	Power Dissipation	79	W
	Linear Derating Factor	0.53	W/°C
V _{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy26	150	mJ
I _{AR}	Avalanche Current①⑥	9.0	A
E _{AR}	Repetitive Avalanche Energy①⑥	7.9	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.0	V/ns
TJ	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	

Thermal Resistance

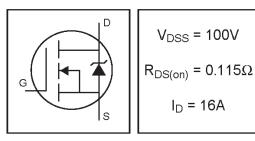
	Parameter	Тур.	Max.	Units
R _{0JC}	Junction-to-Case		1.9	
R _{eja}	Junction-to-Ambient (PCB mount) **		50	°C/W
Reja	Junction-to-Ambient		110	
 and the second	•			

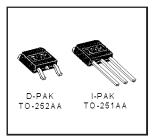
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PD - 95079A

IRFR3910PbF IRFU3910PbF

HEXFET[®] Power MOSFET





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	Parameter	Min.	Тур.	Max.	Units	Conditions
V(BR)DSS	Drain-to-Source Breakdown Voltage	100			V	$V_{GS} = 0V, I_{D} = 250\mu A$
$\Delta V_{(BR)DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.12		V/⁰C	Reference to 25°C, I_D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.115		V _{GS} = 10V, I _D = 10A ④
V _{GS(th)}	Gate Threshold Voltage	2.0		4.0	V	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250 \mu \text{A}$
g fs	Forward Transconductance	6.4			S	V _{DS} = 50V, I _D = 9.0A6
1	Droin to Source Looke as Current			25		V _{DS} = 100V, V _{GS} = 0V
IDSS	Drain-to-Source Leakage Current			250	μA	$V_{DS} = 80V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
1	Gate-to-Source Forward Leakage			100	- 4	V _{GS} = 20V
I _{GSS}	Gate-to-Source Reverse Leakage			-100	nA	V _{GS} = -20V
Qg	Total Gate Charge			44		I _D = 9.0A
Q _{gs}	Gate-to-Source Charge			6.2	nC	V _{DS} = 80V
Q _{gd}	Gate-to-Drain ("Miller") Charge			21		V _{GS} = 10V, See Fig. 6 and 13 ⊕€
t _{d(on)}	Turn-On Delay Time		6.4			V _{DD} = 50V
tr	Rise Time		27			I _D = 9.0A
$t_{d(off)}$	Turn-Off Delay Time		37		ns	$R_G = 12\Omega$
t _f	Fall Time		25			R _D = 5.5Ω, See Fig. 10 ⊕€
	Internal Desir Industry of		4.5			Between lead,
LD	Internal Drain Inductance		4.5		nH	6mm (0.25in.)
1	Internal Course Inductor of		from package			
LS	Internal Source Inductance		7.5	—		and center of die contact [®]
Ciss	Input Capacitance		640			V _{GS} = 0V
Coss	Output Capacitance		160		рF	V _{DS} = 25V
Crss	Reverse Transfer Capacitance		88			f = 1.0MHz, See Fig. 56

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			16	A	MOSFET symbol
	(Body Diode)					showing the
I _{SM}	Pulsed Source Current			60		integral reverse 🔬 🗍
	(Body Diode) ①⑥					p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	V	$T_{\rm J}$ = 25°C, $I_{\rm S}$ = 9.0A, $V_{\rm GS}$ = 0V \circledast
trr	Reverse Recovery Time		130	190	ns	T _J = 25°C, I _F = 9.0A
Qrr	Reverse RecoveryCharge		650	970	nC	di/dt = 100A/µs ⊕ €
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by ${\rm L}_{\rm S}{\rm +L}_{\rm D})$				

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)

④ Pulse width $\leq 300 \mu s;$ duty cycle $\leq 2\%$

- $\ensuremath{\textcircled{S}}$ This is applied for I-PAK, Ls of D-PAK is measured between lead and center of die contact
- $I_{SD} \leq$ 9.0A, di/dt \leq 520A/µs, $V_{DD} \leq V_{(BR)DSS},~$ © Uses IRF530N data and test conditions $T_J \leq 175^{\circ}C$
- ** When mounted on 1" square PCB (FR-4 or G-10 Material).

For recommended footprint and soldering techniques refer to application note #AN-994

2



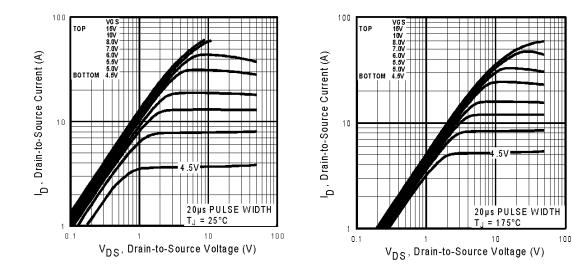


Fig 1. Typical Output Characteristics



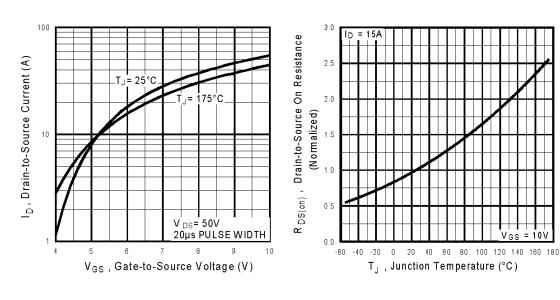


Fig 3. Typical Transfer Characteristics

Fig 4. Normalized On-Resistance Vs. Temperature

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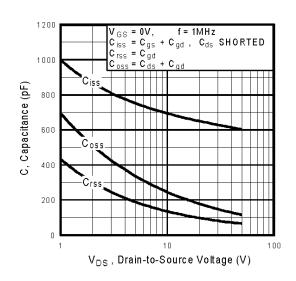


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

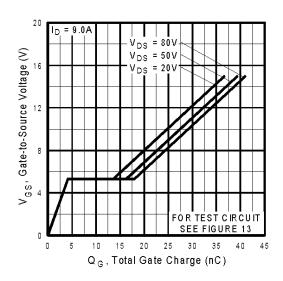
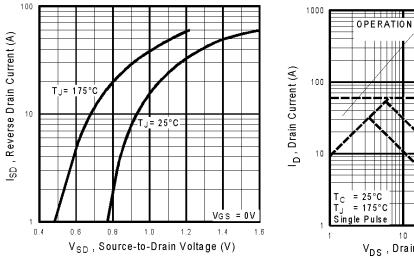


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage





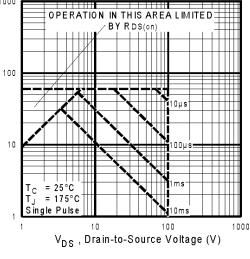
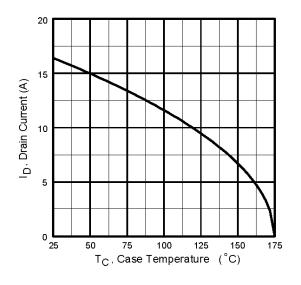
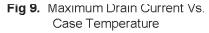


Fig 8. Maximum Safe Operating Area

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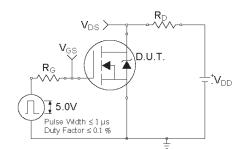


Fig 10a. Switching Time Test Circuit

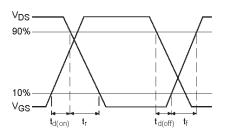


Fig 10b. Switching Time Waveforms

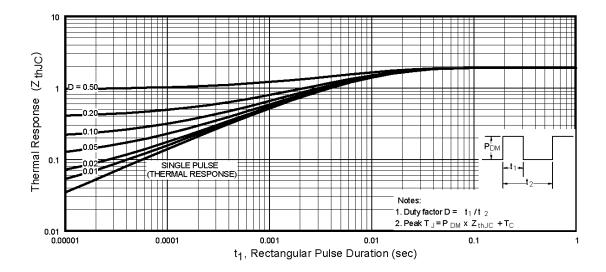


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case www.irf.com

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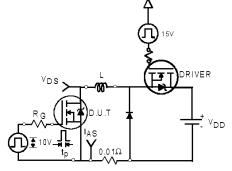


Fig 12a. Unclamped Inductive Test Circuit

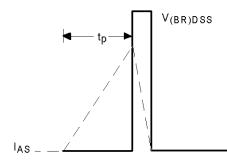


Fig 12b. Unclamped Inductive Waveforms

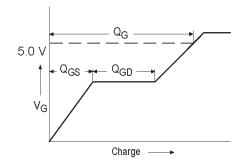


Fig 13a. Basic Gate Charge Waveform

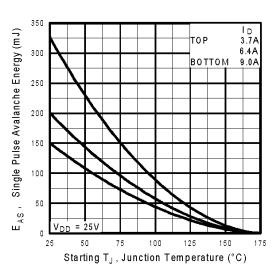


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

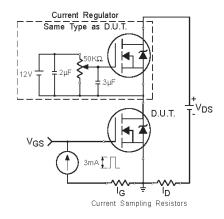
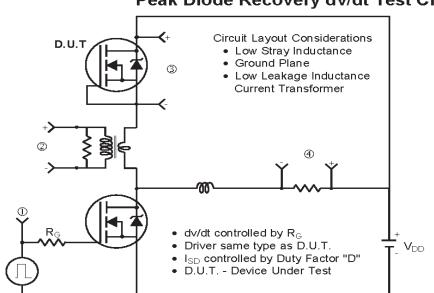


Fig 13b. Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit

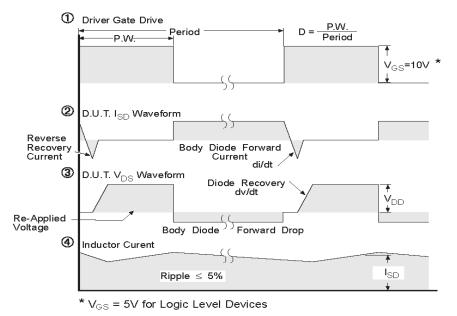
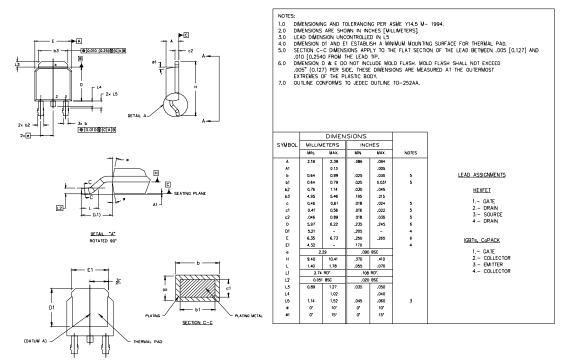


Fig 14. For N-Channel HEXFETS

International **IOR** Rectifier

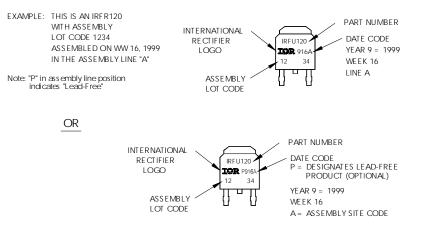
D-Pak (TO-252AA) Package Outline

Dimensions are shown in millimeters (inches)





D-Pak (TO-252AA) Part Marking Information

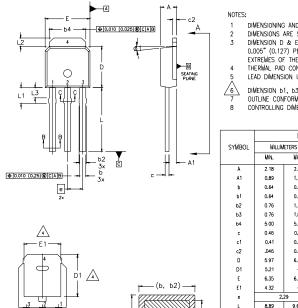


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IRFR/U3910PbF

I-Pak (TO-251AA) Package Outline

Dimensions are shown in millimeters (inches)



(c)

DIMENSIONING AND TOLERANCING PER ASME Y14,5 M- 1994.

DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES]. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES]. DIMENSION D & E DO NOT INCLUDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED 0.005' (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERWOST EXTREMES OF THE FLASTIC BODY. THERMAL PAD CONTOUR OPTION WITHIN DIMENSION 64, L2, E1 & D1.

LEAD DIMENSION UNCONTROLLED IN L3.

INCHES

MAX.

.094

0.045

0.035

0.031

0.045

0.041

0.215

0.024

0.022

0.035

0.245

0.265

0.380

0.090

0.050

0.060

15

NOTES

4

4

3, 4

4

3, 4

4

4

5

DIMENSION 61, 63 APPLY TO BASE METAL ONLY. OUTLINE CONFORMS TO JEDEC OUTLINE TO-251AA.

DIMENSIONS

MAX

2.39

1,14

0.89

0.79 1,14

1.04

5,46

0.61

0,56

0.86

6.22

6.73

9.60

2.29

1,27

1.52

15'

1,91

0.89

1,14

0

CONTROLLING DIMENSION : INCHES.

MIN

0.086

0.035

0.025

0.025

0,030

0.030

0,195

0.018

0.016

0.018

0.235

0.205

0.250

0,170

0,350

0.075

0.035

0.045

0,

0.090 BSC LEAD ASSIGNMENTS

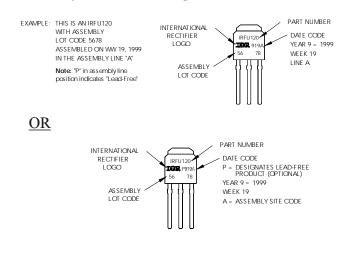
HEXFET 1.- GATE 2.- DRAIN 3.- SOURCE

4.- DRAIN

I-Pak (TO-251AA) Part Marking Information

ь1, ь3

SECTION A-A



L

L1

L2

L3 ø1

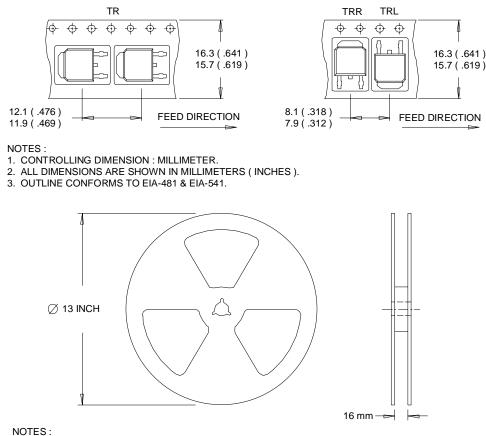
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VIEW A-A

International **ISPR** Rectifier

D-Pak (TO-252AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



1. OUTLINE CONFORMS TO EIA-481.

Data and specifications subject to change without notice.

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